

SERIES: PYB30 | DESCRIPTION: DC-DC CONVERTER
FEATURES

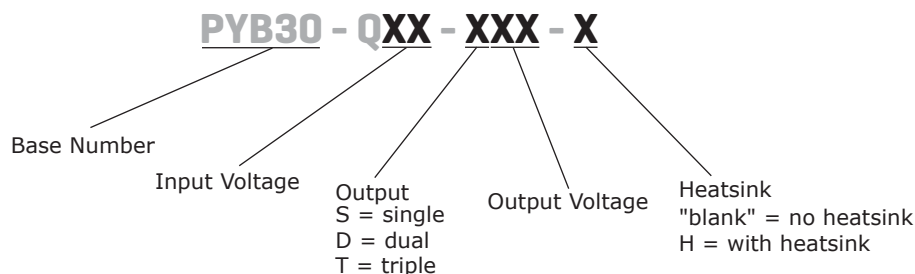
- up to 30 W isolated output
- industry standard pinout
- 4:1 input range (9~36 V, 18~75 V)
- smaller package
- single/dual/triple regulated outputs
- 1,500 Vdc isolation
- continuous short circuit, over current protection, over voltage protection
- temperature range (-40~85°C)
- six-sided metal shielding
- efficiency up to 90%



MODEL	input voltage		output voltage (Vdc)	output current		output power max (W)	ripple and noise ¹ max (mVp-p)	efficiency typ (%)
	typ (Vdc)	range (Vdc)		min (mA)	max (mA)			
PYB30-Q24-S5	24	9~36	5	300	6000	30	100	88
PYB30-Q24-S12	24	9~36	12	125	2500	30	100	88
PYB30-Q24-S15	24	9~36	15	100	2000	30	100	90
PYB30-Q24-D5	24	9~36	±5	±150	±3000	30	100	86
PYB30-Q24-D12	24	9~36	±12	±63	±1250	30	100	89
PYB30-Q24-D15	24	9~36	±15	±50	±1000	30	100	90
PYB30-Q24-T312	24	9~36	3.3 ±12	175 ±31	3500 ±625	26.5	100	85
PYB30-Q24-T315	24	9~36	3.3 ±15	175 ±25	3500 ±500	26.5	100	86
PYB30-Q24-T512	24	9~36	5 ±12	150 ±31	3000 ±625	30	100	88
PYB30-Q24-T515	24	9~36	5 ±15	150 ±25	3000 ±500	30	100	88
PYB30-Q48-S5	48	18~75	5	300	6000	30	100	88
PYB30-Q48-S12	48	18~75	12	125	2500	30	100	88
PYB30-Q48-S15	48	18~75	15	100	2000	30	100	89
PYB30-Q48-D5	48	18~75	±5	±150	±3000	30	100	86
PYB30-Q48-D12	48	18~75	±12	±63	±1250	30	100	87
PYB30-Q48-D15	48	18~75	±15	±50	±1000	30	100	87
PYB30-Q48-T312	48	18~75	3.3 ±12	175 ±31	3500 ±625	26.5	100	85
PYB30-Q48-T315	48	18~75	3.3 ±15	175 ±25	3500 ±500	26.5	100	85
PYB30-Q48-T512	48	18~75	5 ±12	150 ±31	3000 ±625	30	100	88
PYB30-Q48-T515	48	18~75	5 ±15	150 ±25	3000 ±500	30	100	87

Notes: 1. Ripple and noise are measured at 20 MHz BW by "parallel cable" method

PART NUMBER KEY



INPUT

parameter	conditions/description	min	typ	max	units
operating input voltage	24 V input models	9	24	36	Vdc
	48 V input models	18	48	75	Vdc
start-up voltage	24 V input models			9	Vdc
	48 V input models (single/dual output models)			18	Vdc
	48 V input models (triple output models)			17.8	Vdc
under voltage shutdown	24 V input models	7.8			Vdc
	48 V input models	16			Vdc
surge voltage	for maximum of 1 second				
	24 V input models	-0.7		50	Vdc
	48 V input models	-0.7		100	Vdc
start-up time			10		ms
filter	pi filter				
CTRL ¹	models ON (CTRL open or connect high level, 2.5-12 Vdc)				
	models OFF (CTRL connect GND or low level, 0-1.2 Vdc)				
	input current (models OFF)		1		mA

Note: 1. CTRL pin voltage is referenced to GND.

OUTPUT

parameter	conditions/description	min	typ	max	units
line regulation	full load, input voltage from low to high		±0.2	±0.5	%
	single and dual output models			±1	%
	triple output models (main output)			±5	%
	triple output models (auxiliary outputs)				%
load regulation ²	5% to 100% load, nominal input		±0.5	±1	%
	single and dual output models			±2	%
	triple output models (main output)			±5	%
	triple output models (auxiliary outputs)				%
cross regulation	dual output models: main output 50% load, secondary output from 10% to 100% load			±5	%
voltage accuracy	single and dual output models		±1	±3	%
	triple output models (main output)		±1	±3	%
	triple output models (auxiliary outputs)		±3	±5	%
adjustability ³			±10		%
switching frequency	PWM mode		400		KHz
transient recovery time	25% load step change		300	500	µs
transient response deviation	25% load step change		±3	±5	%
temperature coefficient	100% load, single and dual output models			±0.02	%/°C
	100% load, triple output models			±0.03	%/°C

Note: 2. For dual output models, unbalanced load can not exceed ±5%. If ±5% is exceeded, it may not meet all specifications.

3. Output trimming available on single and dual output models only.

PROTECTIONS

parameter	conditions/description	min	typ	max	units
short circuit protection	hiccup, continuous, automatic recovery				
over current protection			150		%
over voltage protection	3.3V output		3.9		Vdc
	5V output		6.2		Vdc
	12V output		15		Vdc
	15V output		18		Vdc

SAFETY AND COMPLIANCE

parameter	conditions/description	min	typ	max	units
isolation voltage	for 1 minute at 1 mA max.	1,500			Vdc
isolation resistance	at 500 Vdc	1,000			MΩ
conducted emissions	CISPR22/EN55022, class A, class B (external circuit required, see Figure 1-b)				
radiated emissions	CISPR22/EN55022, class A, class B (external circuit required, see Figure 1-b)				
ESD	IEC/EN61000-4-2, class B, contact ± 4 kV				
radiated immunity	IEC/EN61000-4-3, class A, 10V/m				
EFT/burst	IEC/EN61000-4-4, class B, ± 2 kV (external circuit required, see Figure 1-a)				
surge	IEC/EN61000-4-5, class B, ± 2 kV (external circuit required, see Figure 1-a)				
conducted immunity	IEC/EN61000-4-6, class A, 3 Vr.m.s				
voltage dips & interruptions	IEC/EN61000-4-29, class B, 0%-70%				
MTBF	as per MIL-HDBK-217F @ 25°C	1,000,000			hours
RoHS compliant	yes				

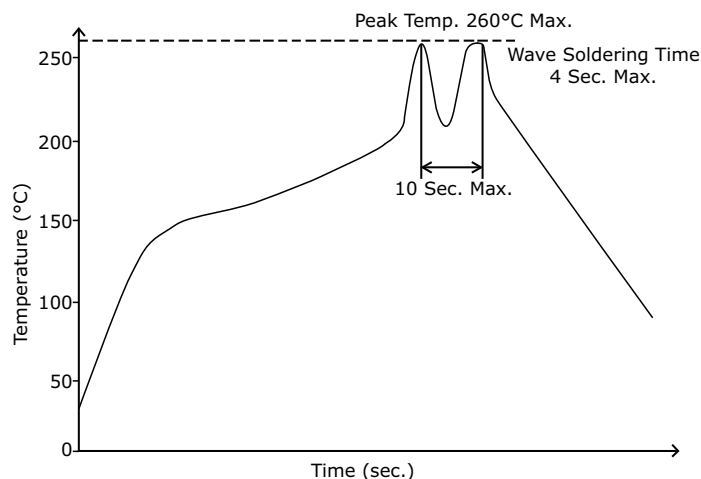
ENVIRONMENTAL

parameter	conditions/description	min	typ	max	units
operating temperature	see derating curve	-40		85	°C
storage temperature		-55		125	°C
storage humidity	non-condensing	5		95	%
case temperature	at full load, Ta=71°C			105	°C

SOLDERABILITY

parameter	conditions/description	min	typ	max	units
hand soldering	1.5 mm from case for 10 seconds			300	°C
wave soldering	see wave soldering profile			260	°C

Wave Soldering Profile



MECHANICAL

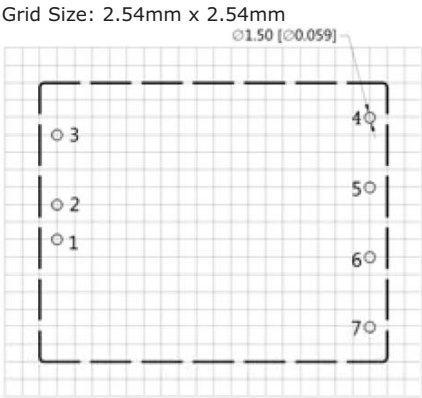
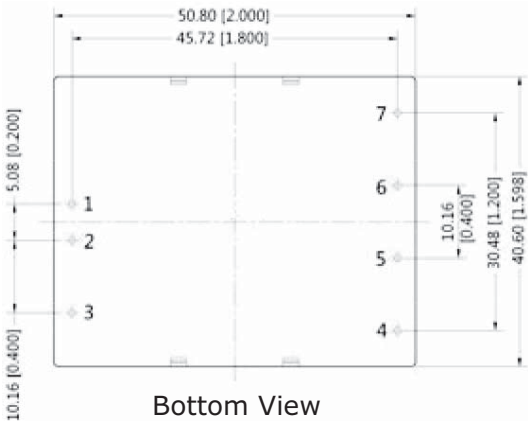
parameter	conditions/description	min	typ	max	units
dimensions	board mount: 50.8 x 40.6 x 11.8				mm
	board mount with heatsink: 50.8 x 40.6 x 16.3				mm
case material	aluminum alloy				
weight	board mount		50		g
	board mount with heatsink		70		g

MECHANICAL DRAWING

BOARD MOUNT

units: mm[inch]
tolerance: $\pm 0.25[\pm 0.010]$
pin diameter tolerance: $\pm 0.10[\pm 0.004]$
pin height tolerance: $\pm 0.50[\pm 0.020]$

PIN CONNECTIONS			
PIN	Single Output	Dual Output	Triple Output
1	Vin	Vin	Vin
2	GND	GND	GND
3	CTRL	CTRL	CTRL
4	Trim	Trim	-Vo2
5	0V	-Vo	0V
6	+Vo	0V	+Vo1
7	NP	+Vo	+Vo2

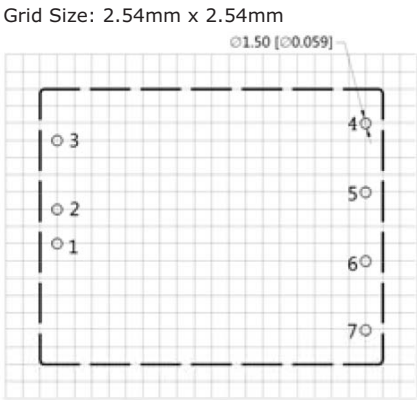
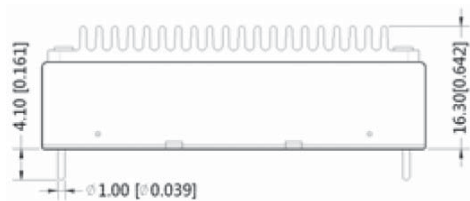
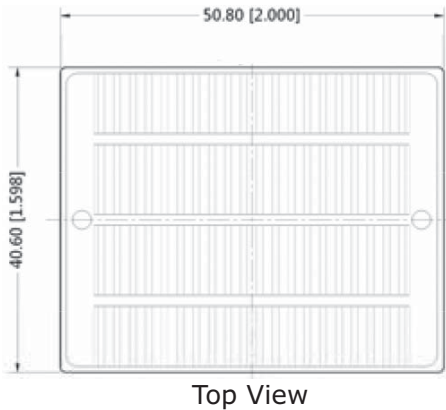


PCB Layout
Top View

BOARD MOUNT WITH HEATSINK

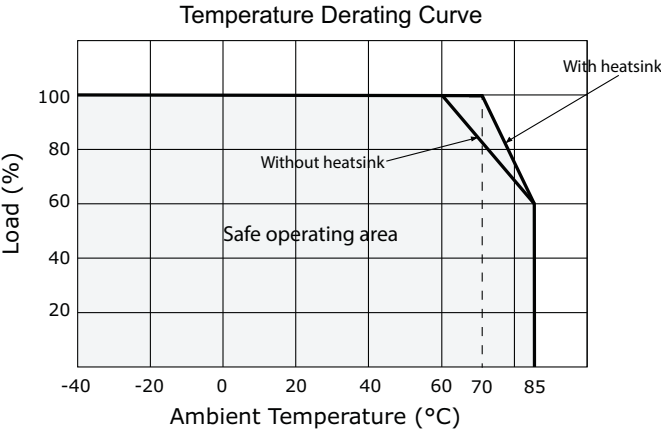
units: mm[inch]
tolerance: $\pm 0.3[\pm 0.012]$
pin diameter tolerance: $\pm 0.10[\pm 0.004]$
pin height tolerance: $\pm 0.50[\pm 0.020]$

PIN CONNECTIONS			
PIN	Single Output	Dual Output	Triple Output
1	Vin	Vin	Vin
2	GND	GND	GND
3	CTRL	CTRL	CTRL
4	Trim	Trim	-Vo2
5	0V	-Vo	0V
6	+Vo	0V	+Vo1
7	NP	+Vo	+Vo2



PCB Layout
Top View

DERATING CURVES



EMC RECOMMENDED CIRCUIT

Figure 1

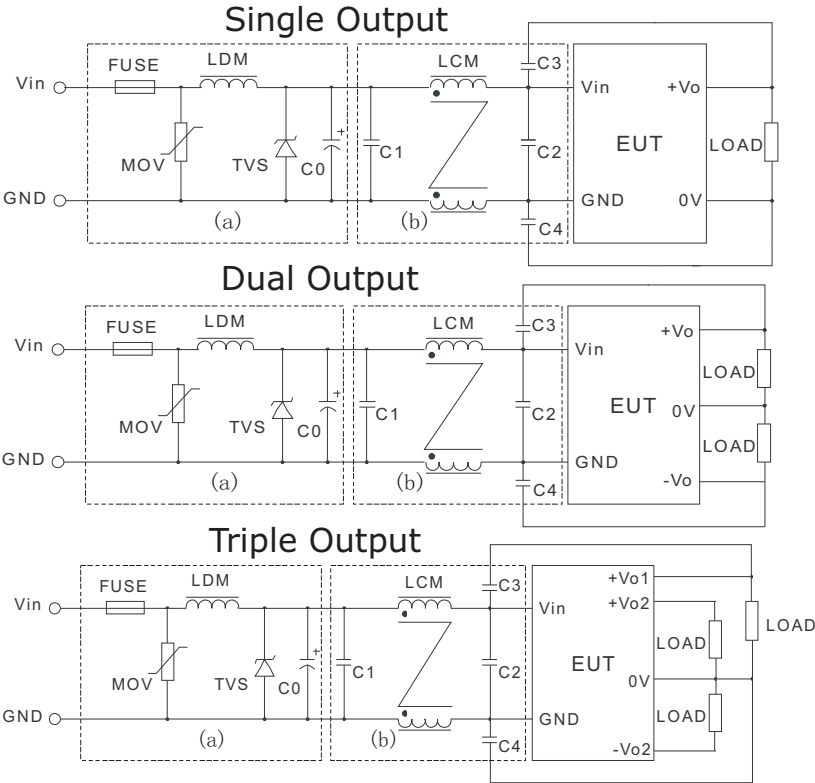


Table 1

Recommended external circuit components		
Vin (Vdc)	24	48
FUSE	Choose according to input current	
MOV	10D560K	10D101K
LDM	56μH	56μH
TVS	SMCJ48A	SMCJ90A
C0	120μF/50V	120μF/100V
C1	4.7μF/50V	2.2μF/100V
LCM	2.2mH	2.2mH
C2	4.7μF/50V	2.2μF/100V
C3*	1nF/2KV	1nF/2KV
C4*	1nF/2KV	1nF/2KV

Note: *2nF/2KV capacitors for triple output, 48V input models.

TEST CONFIGURATION

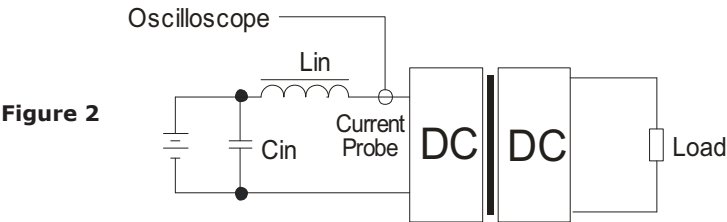


Table 2

External components	
Lin	4.7μH
Cin	220μF, ESR < 1.0Ω at 100 KHz

Note: Input reflected-ripple current is measured with an inductor Lin and Capacitor Cin to simulate source impedance.

APPLICATION NOTES

1. Recommended circuit

This series has been tested according to the following recommended testing circuit before leaving the factory. This series should be tested under load (see Figure 3). If you want to further decrease the input/output ripple, you can increase the capacitance accordingly or choose capacitors with low ESR (see Table 3). However, the capacitance of the output filter capacitor must be appropriate. If the capacitance is too high, a startup problem might arise. For every channel of the output, to ensure safe and reliable operation, the maximum capacitance must be less than the maximum capacitive load (see Table 4).

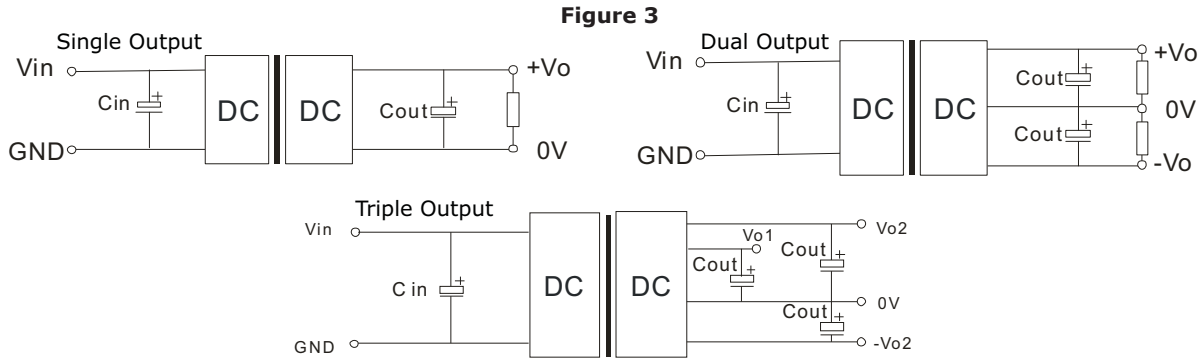


Table 3

Single Vout (Vdc)	Cin (μF)	Cout (μF)	Dual Vout (Vdc)	Cin (μF)	Cout ¹ (μF)	Triple Vout (Vdc)	Cin (μF)	Cout ¹ (μF)
--	--	--	--	--	--	3.3	10	10
5	10	10	±5	10	10	5	10	10
12	10	4.7	±12	10	4.7	±12	10	4.7
15	10	4.7	±15	10	4.7	±15	10	4.7

Note: 1. For each output.

Table 4

Single Vout (Vdc)	Max. Capacitive Load (μF)	Dual Vout (Vdc)	Max. Capacitive Load ¹ (μF)	Triple Vout (Vdc)	Max. Capacitive Load ¹ (μF)
--	--	--	--	3.3/±12	4700/300
5	6000	5	2000	3.3/±15	4700/220
12	2500	12	1250	5/±12	4700/300
15	1100	15	680	5/±15	4700/220

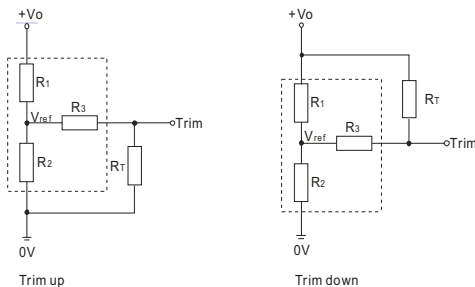
Note: 1. For each output.

2. Output voltage trimming

Leave open if not used.

Figure 4

Application Circuit for Trim pin
(part in broken line is the interior of models)



Formula for Trim Resistor

$$\begin{aligned} \text{up: } R_T &= \frac{aR_2}{R_2 - a} - R_3 & a &= \frac{V_{ref}}{V_o' - V_{ref}} \cdot R_1 \\ \text{down: } R_T &= \frac{aR_1}{R_1 - a} - R_3 & a &= \frac{V_o' - V_{ref}}{V_{ref}} \cdot R_2 \end{aligned}$$

Note: Value for R1, R2, R3, and Vref refer to Table 5
 R_T : Trim Resistor
 a : User-defined parameter, no actual meanings
 V_o' : The trim up/down voltage

Table 5

Vout (Vdc)	R1 (KΩ)	R2 (KΩ)	R3 (KΩ)	Vref (V)
5	2.883	2.864	10	2.5
12	10.971	2.864	17.8	2.5
15	14.497	2.864	17.8	2.5

Note: 1. Minimum load shouldn't be less than 5%, otherwise ripple may increase dramatically. Operation under minimum load will not damage the converter, however, they may not meet all specifications listed.
 2. Maximum capacitive load is tested at input voltage range and full load.
 3. All specifications are measured at $T_a = 25^\circ\text{C}$, humidity < 75%, nominal input voltage and rated output load unless otherwise specified.

REVISION HISTORY

rev.	description	date
1.0	initial release	06/26/2013
1.01	updated spec	08/15/2013

The revision history provided is for informational purposes only and is believed to be accurate.

**CUI INC[®]**

Headquarters
20050 SW 112th Ave.
Tualatin, OR 97062
800.275.4899

Fax 503.612.2383
cui.com
techsupport@cui.com

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